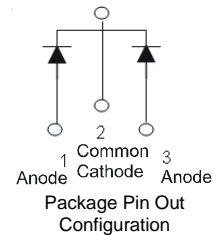
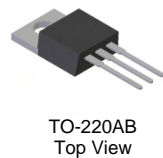


Features

- Low Forward Voltage Drop
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 175°C Operating Junction Temperature
- **Lead Free Finish, RoHS Compliant (Note 2)**
- **Also Available in Green Molding Compound (Note 5)**

Mechanical Data

- Case: TO-220AB
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 1.85 grams (approximate)



Maximum Ratings (Per Leg) @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|---|-----------|----------|------|
| Peak Repetitive Reverse Voltage | V_{RRM} | 100 | V |
| Working Peak Reverse Voltage | V_{RWM} | | |
| DC Blocking Voltage | V_{RM} | | |
| Average Rectified Output Current Per Device (Per Leg) (Total) | I_O | 30 60 | A |
| Non-Repetitive Peak Forward Surge Current 8.3mS Single Half Sine-Wave Superimposed on rated load | I_{FSM} | 350 | A |

Thermal Characteristics (Per Leg)

| Characteristic | Symbol | Value | Unit |
|--|-----------------|-------------|---------------------------|
| Typical Thermal Resistance | | | |
| Thermal Resistance Junction to Case (Note 3) | $R_{\theta JC}$ | 1.0 | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction to Ambient (Note 3) | $R_{\theta JA}$ | 10.0 | |
| Operating and Storage Temperature Range | T_J, T_{STG} | -55 to +175 | $^\circ\text{C}$ |

Electrical Characteristics (Per Leg) @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|--------------------------|--------|-----|-----------|--------------|---------------------|---|
| Forward Voltage Drop | V_F | - | - 0.65 | 0.84 0.72 | V | $I_F = 30\text{A}, T_J = 25^\circ\text{C}$ $I_F = 30\text{A}, T_J = 125^\circ\text{C}$ |
| Leakage Current (Note 1) | I_R | - | - 12.7 | 500 75 | μA mA | $V_R = 100\text{V}, T_J = 25^\circ\text{C}$ $V_R = 100\text{V}, T_J = 125^\circ\text{C}$ |

- Notes:
1. Short duration pulse test used to minimize self-heating effect.
 2. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.
 3. Device mounted on heatsink (Black Aluminum, 37mm x 50mm x 15mm)

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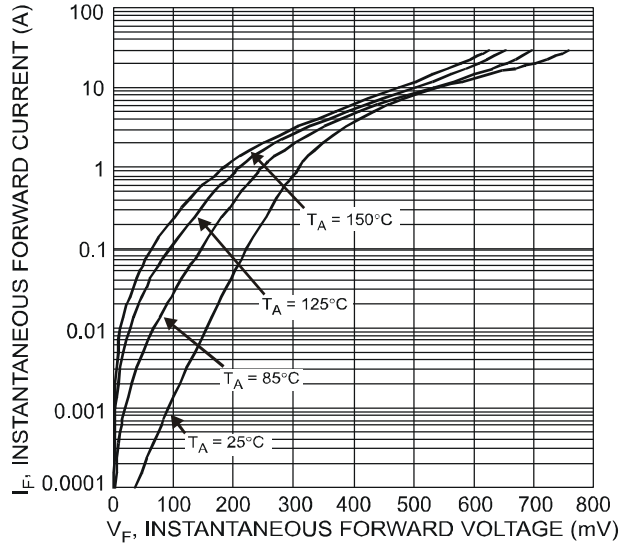


Fig. 1 Typical Forward Characteristics

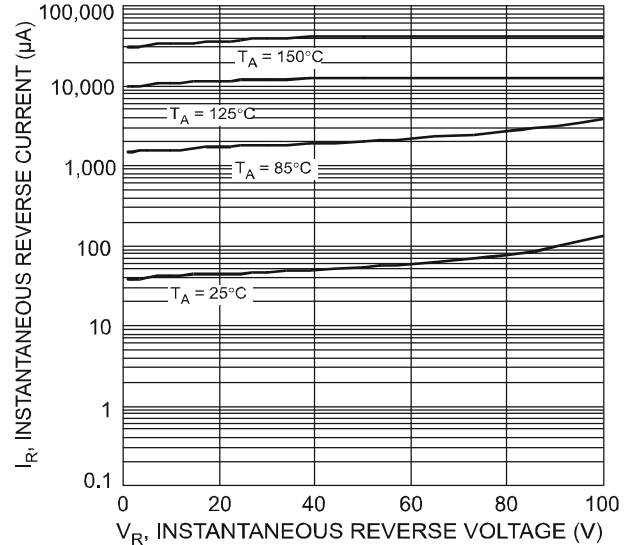


Fig. 2 Typical Reverse Characteristics

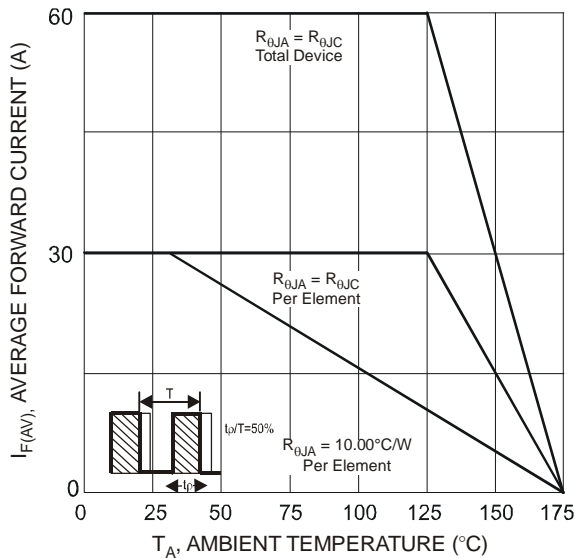


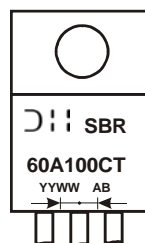
Fig. 3 Forward Current Derating Curve

Ordering Information (Notes 4 & 5)

| Part Number | Case | Packaging |
|---------------|----------|----------------|
| SBR60A100CT | TO-220AB | 50 pieces/tube |
| SBR60A100CT-G | TO-220AB | 50 pieces/tube |

Notes: 4. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.
5. For Green Molding Compound version part numbers, add "-G" suffix to part number above. Examples: SBR60A100CT-G.

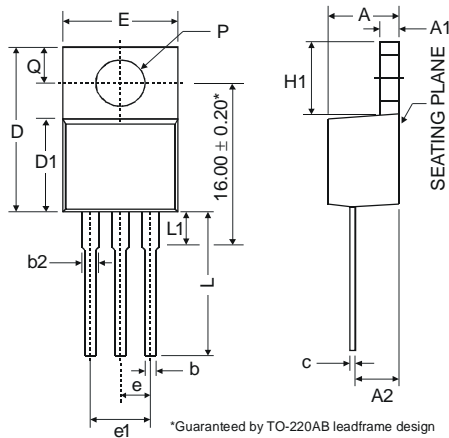
Marking Information



SBR60A100CT = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last two digits of year (ex: 08 = 2008)
 WW = Week (01-52)

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Package Outline Dimensions



| TO-220AB | | | |
|-----------------------------|-------|------|-------|
| Dim | Min | Typ | Max |
| A | 3.56 | - | 4.82 |
| A1 | 0.51 | - | 1.39 |
| A2 | 2.04 | - | 2.92 |
| b | 0.39 | 0.81 | 1.01 |
| b2 | 1.15 | 1.24 | 1.77 |
| c | 0.356 | - | 0.61 |
| D | 14.22 | - | 16.51 |
| D1 | 8.39 | - | 9.01 |
| e | 2.54 | | |
| e1 | 5.08 | | |
| E | 9.66 | - | 10.66 |
| H1 | 5.85 | - | 6.85 |
| L | 12.70 | - | 14.73 |
| L1 | - | - | 6.35 |
| P | 3.54 | - | 4.08 |
| Q | 2.54 | - | 3.42 |
| All Dimensions in mm | | | |

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Document number: DS31385 Rev. 4 - 2

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